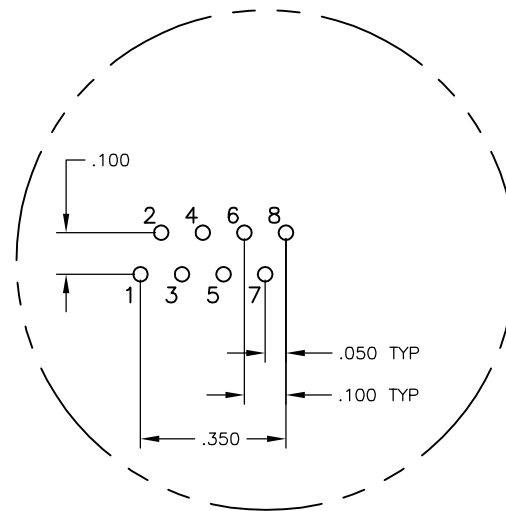
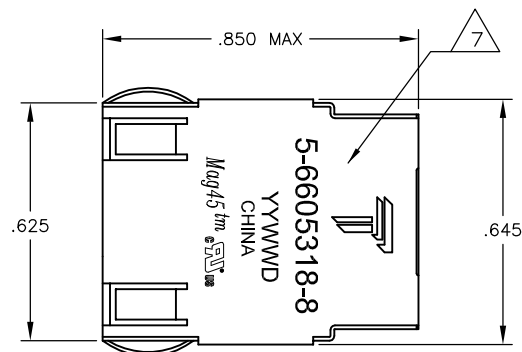
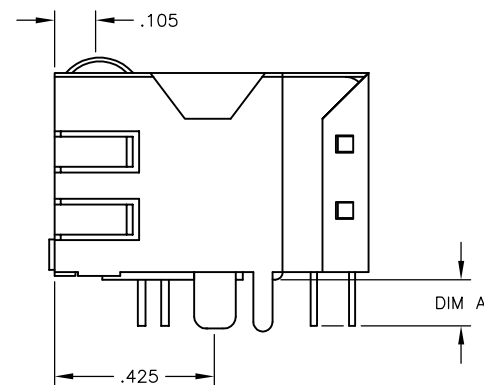
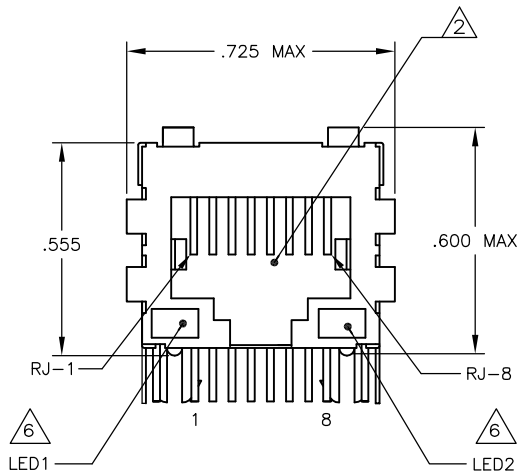


REVISIONS					
#	LR	DESCRIPTION	DATE	BY	APP
E		LOGO CHANGE	23APR2013	JC	KZ

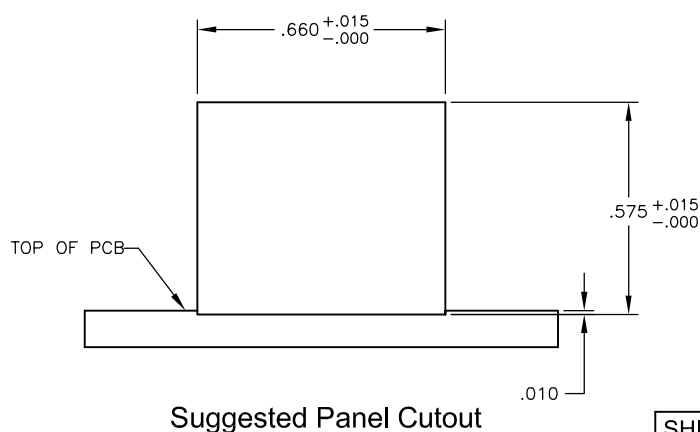
MECHANICAL:



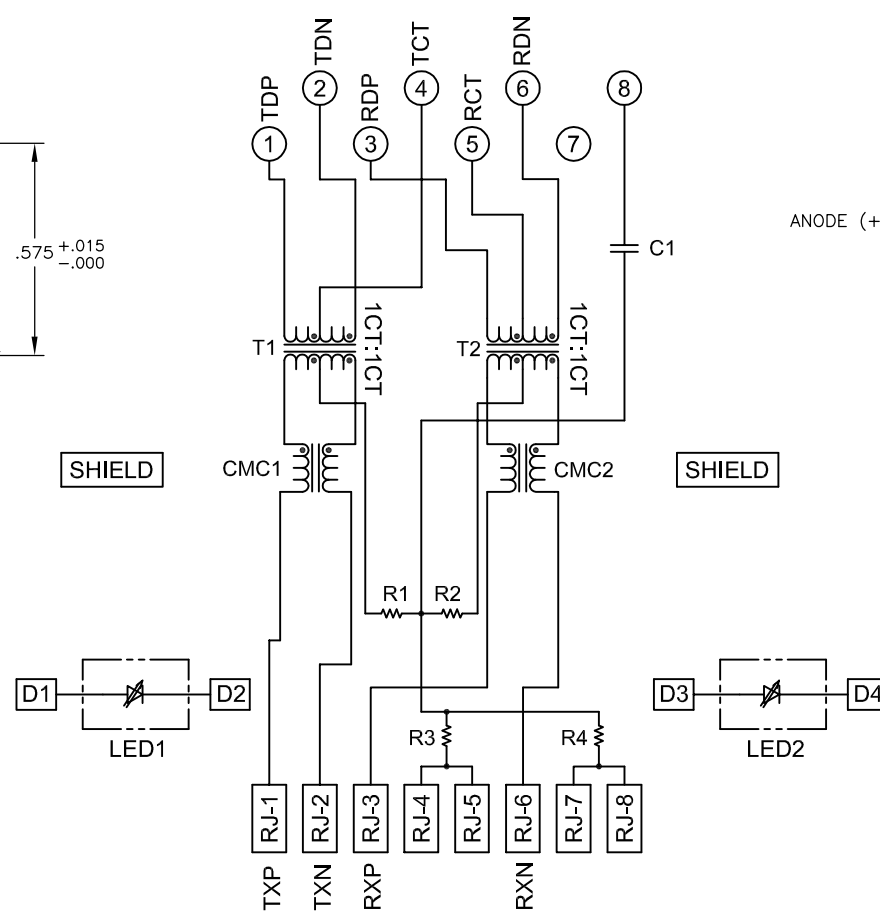
Pin Designations



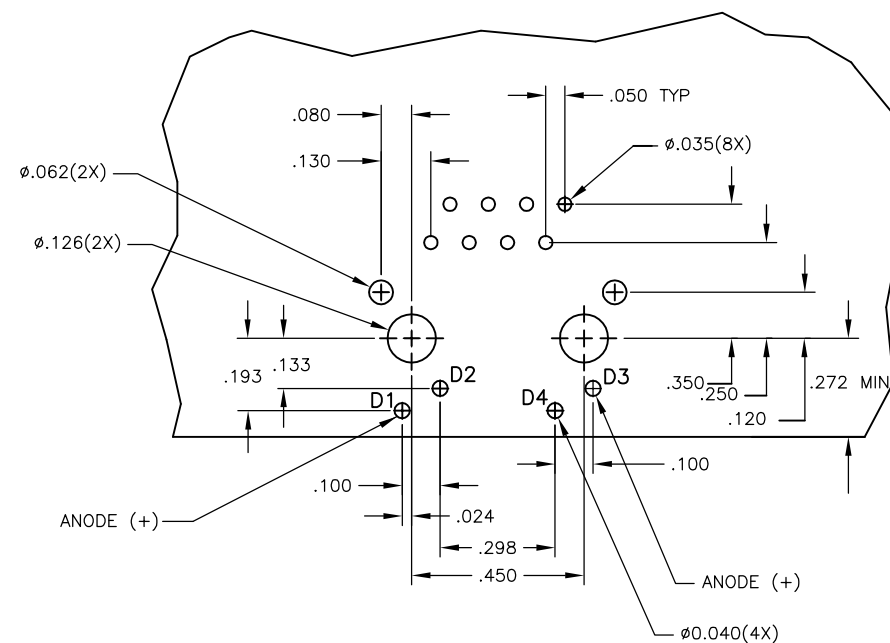
ELECTRICAL:
326P13 MAGNETIC CIRCUIT



Suggested Panel Cutout



C1=1000 pF, 2kV CAPACITOR
R1-R4 = 75 OHMS, 1/16 W RESISTORS



Suggested PCB Layout
(Component Side)

△ MATERIALS:
HOUSING - THERMOPLASTIC PET POLYESTER FLAMMABILITY RATING UL 94V-0.
SHIELD - .010" THICK, C26800 BRASS PREPLATED WITH 30μINCH SEMI-BRIGHT NICKEL. SOLDER TABS POST DIPPED WITH 100μINCH MIN SAC SOLDER.
MOD JACK CONTACTS - 0.0157 X 0.018" PHOSPHOR BRONZE, 50μINCH MIN OVERALL NICKEL UNDERPLATE, WITH SELECT 50μINCH MIN HARD GOLD FINISH PLATE SOLDERTAILS WITH 100μINCH MIN MATTE TIN AND/OR SAC SOLDER DIP.
LIGHT EMITTING DIODE(LED) - DIFFUSED EPOXY LENS, .020" x .020" CARBON STEEL WIREFRAME LEADS PRE-PLATED WITH 80μINCH SILVER OVER 40μINCH NICKEL UNDERPLATE OVER 40μINCH COPPER UNDERPLATE. POST-PLATED WITH 100μINCH MIN MATTE TIN AND/OR SAC SOLDER DIP OR PURE TIN SOLDER DIP.

△ RJ45 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUB PART F.

△ MAGNETICS
-IMPEDANCE: 100 OHMS
-TURNS RATIO (CHIP:CABLE): TX = 1:1, RX = 1:1
-OPEN CIRCUIT INDUCTANCE (OCL): 350μH MIN @100kHz, 0.1VRMS, 8mADC BIAS FROM 0°C TO 70°C, TX AND RX
-PERFORMANCE @ 25°C:
INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHZ TO 100MHZ
RETURN LOSS (RL): 18dB MIN FROM 0.5MHZ TO 30MHZ
18-20LOG(f/30)dB MIN FROM 30.1MHZ TO 60MHZ
12dB MIN FROM 60.1MHZ TO 80MHZ
CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHZ TO 40MHZ
33-20*LOG(f/50)dB MIN FROM 40.1MHZ TO 100MHZ
COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHZ TO 100MHZ
-ISOLATION VOLTAGE: 2250VDC (MAX) FOR 60 SECONDS WITH A RISE TIME OF 500V/SEC.

4. OPERATING TEMPERATURE: FROM 0°C TO +70°C.

△ INDICATED CONNECTIONS ARE FOR NIC CONFIGURATION. THE MAGNETICS ARE SYMMETRICAL, AND SUPPORTS AUTO-MDI/MDIX.

△ LEDS WITHOUT BUILT-IN RESISTOR
LEDS ARE DRIVEN WITH CONSTANT CURRENT AT APPROX 20 mA
LED COLOR: DOMINANT WAVELENGTH (AD): GREEN 568 nm TYP @ IF=20 mA
FORWARD VOLTAGE (VF): GREEN 2.2V TYP @ IF=20 mA
DOMINANT WAVELENGTH (AD): YELLOW 588 nm TYP @ IF=20 mA
FORWARD VOLTAGE (VF): YELLOW 2.1V TYP @ IF=20 mA
DOMINANT WAVELENGTH (AD): ORANGE 605 nm TYP @ IF=20 mA
FORWARD VOLTAGE (VF): ORANGE 2.1V TYP @ IF=20 mA

△ TRP CONNECTOR LOGO, PART NUMBER, DATE CODE, COUNTRY OF ORIGIN AND AGENCY APPROVAL MARKING IN APPROXIMATE LOCATION SHOWN.

8. THESE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PREHEAT TEMPERATURE IS 120°C TO 160°C, 120 SECONDS TO 180 SECONDS, PEAK WAVE SOLDERING TEMPERATURE IS 260°C MAX, 10 SECONDS MAX.

.145±.010	GREEN	YELLOW	5-6605318-8
.110±.010	GREEN	YELLOW	6605318-8
DIM A	LED1 △	LED2 △	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DRN: G. ATTADIA - 07MAR2005	TRP connector
DIMENSIONS: INCHES		CHK: D. FAROLE - 07MAR2005	Dongguan China
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPD: D. FAROLE - 07MAR2005	
0 PLC	± -	PRODUCT SPEC	NAME 1X1 MAG45(TM), 4N2P13 10/100 ETHERNET SCHEMATIC, 326P13 MAGNETIC CIRCUIT, SHIELDED, DECOUPLING CAPACITOR, WITH LEADS
1 PLC	± .010	APPLICATION SPEC	SIZE CASE CODE DRAWING NO
2 PLC	± .005		A1 C-6605318
3 PLC	± .005		RESTRICTED TO
4 PLC	± .005		
ANGLES	± -		
MATERIAL	FINISH	WEIGHT	
1	1		
CUSTOMER DRAWING		SCALE NTS	SHEET 1 OF 1 REV E